

20th Anniversary of KSDT  
**KISM 2022**  
Korean International Semiconductor Conference on Manufacturing Technology 2022  
November 13-16, 2022 | Paradise Hotel Busan (Haeundae Beach), Busan, Korea

---

---

<b>Session Title:</b>	[TE2] 3D Package II
<b>Session Date:</b>	November 15 (Tue.), 2022
<b>Session Time:</b>	11:20-12:20
<b>Session Room:</b>	Room E (Grand Ballroom 3, 2F)
<b>Session Chair:</b>	Prof. Changhwan Choi (Hanyang Univ., Korea)

---

[TE2-1] [Invited] 11:20-11:50

Heterogeneous 3D Integration Technology for Future Information Systems  
Mitsumasa Koyanagi (Tohoku Univ., Japan)

[TE2-2] [Invited] 11:50-12:20

3D Package Technology, "The New Boundary of Si and Package Technology"  
Dae-Woo Kim (Samsung Electronics Co., Ltd., Korea)